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Intel® NUC Kit NUC7i7DNKE

Specifications

Export specifications

Essentials

Product Intel® NUC Kit with 8th Generation Intel® Core™ Processors Collection				
Code Name Products formerly Dawson Canyon				
Status	Launched			
Launch Date	Q1'18			
Supported Operating Systems Windows 10, 64-bit*, Windows 10 IoT Enterprise*, Ubuntu 16.04*				
Board Number	NUC7i7DNB			
Board Form Factor	UCFF (4" x 4")			
Socket	Soldered-down BGA			
Internal Drive Form Factor	M.2 SSD			
# of Internal Drives Supported	1			
TDP	15 W			
DC Input Voltage Supported	12-24 VDC			
Processor Intel® Core™ i7-8650U Processor (8M Cache, up to 4.20 GHz)				
Intel vPro® Platform Eligibility ‡	Yes			
# of Cores	4			
# of Threads	8			
Processor Base Frequency	1.90 GHz			
Max Turbo Frequency	4.20 GHz			
Warranty Period	3 yrs			
Recommended Customer Price	\$555.92 - \$558.38			

Supplemental Information

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Embedded Options Available		Yes
Description	8th Gen	Commercial Intel® NUC
emory & Storage		
(Max Memory Size (dependent on memory type)		32 GE
Memory Types	DDR	4-2400 1.2V SO-DIMM
Max # of Memory Channels		2
Max # of DIMMs		2
ECC Memory Supported ‡		No
rocessor Graphics		
Processor Graphics ‡	In	tel® UHD Graphics 620
Integrated Graphics ‡		Ye
Graphics Output	Dual HD	MI 2.0a, 4-lane eDP 1.4
# of Displays Supported ‡		:
PCI Express Revision		
	e x4: M.2 22x80 (key M) slot PCIe x1	
PCI Express Configurations ‡ PCI M.2 Card Slot (wireless)	e x4: M.2 22x80 (key M) slot PCIe x1	M.2 22x30 (key E) slo 22x30 (key E) slo
PCI Express Configurations ‡ PCI	e x4: M.2 22x80 (key M) slot PCIe x1:	M.2 22x30 (key E) slo 22x30 (key E) slo
PCI Express Configurations ‡ PCI M.2 Card Slot (wireless) M.2 Card Slot (storage)	e x4: M.2 22x80 (key M) slot PCIe x1:	M.2 22x30 (key E) slo
PCI Express Configurations ‡ PCI M.2 Card Slot (wireless) M.2 Card Slot (storage)	e x4: M.2 22x80 (key M) slot PCIe x1:	22x30 (key E) slo 22x30 (key E) slo 22x80 (key M) slo
PCI Express Configurations ‡ PCI M.2 Card Slot (wireless) M.2 Card Slot (storage) O Specifications # of USB Ports	e x4: M.2 22x80 (key M) slot PCIe x1	22x30 (key E) slo 22x30 (key E) slo 22x80 (key M) slo
PCI Express Configurations ‡ M.2 Card Slot (wireless) M.2 Card Slot (storage) O Specifications # of USB Ports		22x30 (key E) slo 22x30 (key E) slo 22x80 (key M) slo 22x80 (via internal header
PCI Express Configurations ‡ M.2 Card Slot (wireless) M.2 Card Slot (storage) O Specifications # of USB Ports USB Configuration 2x front and 2x research		22x30 (key E) slo 22x30 (key E) slo 22x80 (key M) slo 22x80 (via internal header 2.0, 3.0
PCI Express Configurations † PCI M.2 Card Slot (wireless) M.2 Card Slot (storage) O Specifications # of USB Ports USB Configuration 2x front and 2x re USB Revision		2.0, 3.0 (key E) slo
PCI Express Configurations † M.2 Card Slot (wireless) M.2 Card Slot (storage) D Specifications # of USB Ports USB Configuration 2x front and 2x re USB Revision USB 2.0 Configuration (External + Internal)		2.0, 3.6 2 2 2 2 2 2 2 3 0 (key E) slo 2 2 2 2 8 0 (key M) slo 2 2 2 0 via internal header 2 2 0 , 3.6 2 2 2 2 5 + 2
PCI Express Configurations ‡ PCI M.2 Card Slot (wireless) M.2 Card Slot (storage) D Specifications # of USB Ports USB Configuration 2x front and 2x re USB Revision USB 2.0 Configuration (External + Internal) USB 3.0 Configuration (External + Internal)		22x30 (key E) slo 22x30 (key E) slo 22x80 (key M) slo 22x80 (key M) slo 2.0 via internal header 2.0, 3.0 0 + 3
PCI Express Configurations ‡ PCI M.2 Card Slot (wireless) M.2 Card Slot (storage) D Specifications # of USB Ports USB Configuration 2x front and 2x re USB Revision USB 2.0 Configuration (External + Internal) USB 3.0 Configuration (External + Internal) Total # of SATA Ports		2.0, 3.0 2B 2F +
PCI Express Configurations ‡ PCI M.2 Card Slot (wireless) M.2 Card Slot (storage) O Specifications # of USB Ports USB Configuration 2x front and 2x re USB Revision USB 2.0 Configuration (External + Internal) USB 3.0 Configuration (External + Internal) Total # of SATA Ports Max # of SATA 6.0 Gb/s Ports		22x30 (key E) slo 22x80 (key M) slo
PCI Express Configurations ‡ PCI M.2 Card Slot (wireless) M.2 Card Slot (storage) O Specifications # of USB Ports USB Configuration USB Revision USB 2.0 Configuration (External + Internal) USB 3.0 Configuration (External + Internal) Total # of SATA Ports Max # of SATA 6.0 Gb/s Ports RAID Configuration	ear USB 3.0; 1x USB 3.0 and 2x USB 2	2.0, 3.0 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 3 2 3 2

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Additional Headers Front_panel (PWR, RST, 5V, 5Vsby, 3.3Vsby); HDMI_CEC;	Internal 2x2 power connector
Package Specifications	
Chassis Dimensions	115 x 111 x 36 mm
Advanced Technologies	
Intel® Virtualization Technology for Directed I/O (VT-d) ‡	Yes
Intel vPro® Platform Eligibility ‡	Yes
Intel® ME Firmware Version	v11.8
ТРМ	Yes
TPM Version	2.0
Intel® Rapid Storage Technology	Yes
Intel® Virtualization Technology (VT-x) ‡	Yes
Intel® Platform Trust Technology (Intel® PTT)	No
Security & Reliability	
Intel® AES New Instructions	Yes
	Yes

Ordering and Compliance

Product Images

Compatible Products

Drivers and Software

Technical Documentation

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Refer to Datasheet for formal definitions of product properties and features.

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‡ This feature may not be available on all computing systems. Please check with the system vendor to determine if your system delivers this feature, or reference the system specifications (motherboard, processor, chipset, power supply, HDD, graphics controller, memory, BIOS, drivers, virtual machine monitor-VMM, platform software, and/or operating system) for feature compatibility. Functionality, performance, and other benefits of this feature may vary depending on system configuration.

System and Maximum TDP is based on worst case scenarios. Actual TDP may be lower if not all I/Os for chipsets are used.

"Announced" SKUs are not yet available. Please refer to the Launch Date for market availability.

Some products can support AES New Instructions with a Processor Configuration update, in particular, i7-2630QM/i7-2635QM, i7-2670QM/i7-2675QM, i5-2430M/i5-2435M, i5-2410M/i5-2415M. Please contact OEM for the BIOS that includes the latest Processor configuration update.

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